

Sound Processors for BOOM BOX / Mini-component Stereo

Sound Processors with Built-in 3-band Equalizers





BD3403FV, BD3861FS, BD3883FS

No.10086EAT01

Description

The Sound Processor has a built-in 3 Band Equalizer and can be controlled with a 2-wire serial. It is suited for a sound quality design which incorporates various functions, ranging from source selectors, such as BOOM BOX, Mini-audio systems and Micro-audio systems to preamplifiers at the front stage of the power amp.

Features

- 1) High S/N, achieved by implementing 2-stage configuration of Front Volume and Rear Volume.
- 2) Provides surround and rear volume with Soft-switch to reduce a shock sound during switching functions(BD3883FS).
- Volume and tone implemented with the resistance ladder circuit (to achieve high performance with low noise and low distortion).
- 4) Uses the BiCMOS process that achieves low-consumption current, which contributes to an energy-saving design.
 Using the BiCMOS process, has the advantage in quality over the scaling down of the internal regulators and heat controls.
- 5) SSOP-A32 and SSOP-B40 are used for the packages. Input pins and output pins are organized and separately laid out so as to keep the signal flows in one direction which consequently, simplify pattern layout of the set board and decrease the board dimensions.

Applications

BOOM BOX, mini-audio systems, and micro-audio systems.

Product lineup

Parameter	BD3403FV	BD3861FS	BD3883FS	
Operating Voltage Range	6.5 to 9.5V	6.5 to 9.5V	6.5 to 9.5V	
Equalizer	3 band (BASS, MIDDLE, TREBLE)	3 band (BASS, MIDDLE, TREBLE)	3 band (BASS, MIDDLE, TREBLE)	
Front Volume	0 to -30dB/2dB step	0 to -50dB/2dB step -50 to -70dB/4dB step, -∞dB	0 to -87dB/1dB step, -∞dE	
Rear Volume	0 to -59dB/1dB step, -∞dB	0 to -59dB/1dB step, -∞dB	0, -10dB	
Input Gain	0 to 26dB/2dB step	0 to 26dB/2dB step	0, 6, 12, 16, 20, 23, 26, 29dB	
Microphone Input	0	0	-	
Surround	0	-	0	
Package	SSOP-B40	SSOP-A32	SSOP-A32	

■Absolute maximum ratings (Ta=25°C)

Desired Healtham Fallings (Fall-2019)									
Prameter	Symbol	Rat	Ratings						
Prameter	Symbol	BD3403FV	BD3861FS,BD3883FS	Unit					
Power Supply Voltage	Vcc	10	10	V					
Power Dissipation	Pd	900 ^{*1}	950 ^{*2}	mW					
Input Voltage Range	Vin	GND-0.3 to VCC+0.3	GND-0.3 to VCC+0.3	V					
Operating Temperature Range	Topr	-25 to +75	-25 to +75	°C					
Storage Temperature Range	Tstg	-55 to +125	-55 to +125	°C					

¹ Reduced by 9.0 mW/°C over 25°C, when installed on the standard board (size: 70×70×1.6mm) for (BD3403FV).

Operating voltage range

Prameter	Symbol	Ratings	Unit
BD3403FV			
BD3861FS	Vcc	6.5 to 9.5	V
BD3883FS			

² Reduced by 9.5 mW/°C over 25°C, when installed on the standard board (size:70×70×1.6mm) for (BD3861FS,BD3883FS).

Electrical characteristics

@BD3403FV

 $V_{\text{CC}}\text{=}9V\text{, }f\text{=}1\text{KHz},\text{ }V\text{IN}\text{=}1\text{Vrms},\text{ }R\text{g}\text{=}600\Omega,\text{ }R\text{L}\text{=}10\text{k}\Omega,\text{ }T\text{a}\text{=}25^{\circ}\text{C},\text{ }I\text{nput Gain}\text{=}0\text{dB},\text{ }V\text{OL}\text{=}0\text{dB},\text{ }V\text{$

Bass, Middle, Treble=0dB, Surround=OFF, unless otherwise noted.

Dass	Bass, Middle, Treble=UdB, Surround=OFF, unless otherwise noted. Limits								
	Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition		
	Circuit Current	Ŋ	-	16.0	30.0	mA	At no signal		
	Output Voltage Gain	GV	-1.5	0.0	1.5	dB	GV=20log(VOUT/VIN)		
٦	Total Harmonic Distortion ratio	THD	-	0.02	0.08	%	400 to 30kHz BPF		
TOTAL	Maximum Output Voltage	VOM	2.0	2.5	-	Vrms	THD=1%		
'	Output Noise Voltage	VNO	-	1.8	6.0	μVrms	Rg=0kΩ, IHF-A		
	Cross-talk between Channels	СТ	-	3.0	9.0	μVrms	Rg=0kΩ, IHF-A		
	6dBSW Gain	GV6	5	6	7	dB	VIN=200mVrms GV6=20log(VOUT/VIN)		
	Input Voltage Gain 1	GvmaxI1	-1	*2	+1	dB	VIN=200mVrms, From 0 to 10dB Gvmaxl1=20log(VOUT/VIN)		
	Input Voltage Gain 2	GvmaxI2	-1.5	*2	+1.5	dB	VIN=200mVrms From 12 to 26dB Gvmaxl2=20log(VOUT/VIN)		
5	Input Gain Switching Step	Gvmaxlst	-	2	-	dB	From 0 to 26dB		
INPUT	Input Total Harmonic Distortion ratio	THDI	-	0.02	0.08	%	400 to 30kHz BPF		
	Input Maximum Output Voltage	VOMI	2.0	2.5	-	dB	THD=1%		
	Cross-talk between Selectors	CS	-	-80.0	-70.0	dB	Rg=0kΩ, IHF-A CS=20log(VOUT/VIN)		
	Input Impedance	RI	35.0	50.0	65.0	kΩ	RI=51k×VOUT/ (VIN-VOUT)		
	E Input SW Attenuation	GRE	-	-20.0	-15.0	dB	GRE=20log(VOUT/VIN)		
INPUT	Input Volume 1	GIV1	-2	*3	+2	dB	From 0 to -30dB GIV1=20log(VOUT/VIN)		
ĮΞ̈́δ	Volume Switching Step 1	GIVst1	-	2	-	dB	From 0 to -30dB		
OUTPUT	Output Volume	GOV	-1	*1	+1	dB	From 0 to -59dB Gov=20log(VOUT/VIN)		
153	Output Switching Step	GOVst	-	1	-	dB	From 0 to -59dB		
5 ≥	Maximum attenuation	GminO	-	-	-90.0	dB	IHF-A, GminO=20log(VOUT/VIN)		
dNnc	Surround Gain CH1→CH2	Gsur1	5	7	9	dB	V _{IN} =200mVrms, f=1kHz		
SURROUND	Surround Gain CH2→CH1	Gsur2	5	7	9	dB	V _{IN} =200Vrms, f=1kHz		
(0	Bass Boost Gain	GBB	-2	*1	+2	dB	V _{IN} =200mVrms, f=90Hz, From 0 to 14dB GBB=20log(VOUT/VIN)		
BASS	Bass Cut Gain	GBC	-2	*1	+2	dB	V _{IN} =200mVrms, f =90Hz, From -14 to 0dB GBC=20log(VOUT/VIN)		
	Bass Switching Step	GBST	-	2	-	dB	V _{IN} =200mVrms, f=90Hz		
щ	Middle Boost Gain	GMB	-2	*1	+2	dB	V _{IN} =200mVrms, From 0 to 12dB GMB=20log(VOUT/VIN)		
MIDDLE	Middle Cut Gain	GMC	-2	*1	+2	dB	V _{IN} =200mVrms, From -12 to 0dB GMC=20log(VOUT/VIN)		
2	Middle Switching Step	GMST	-	2	-	dB	V _{IN} =200mVrms		
"	Treble Boost Gain	GTB	-2	*1	+2	dB	V _{IN} =200mVrms, f=10kHz From 0 to 12dB GTB=20log(VOUT/VIN)		
TREBLE	Treble Cut Gain	GTC	-2	*1	+2	dB	V _{IN} =200mVrms, f=10kHz From -12 to 0dB GTC=20log(VOUT/VIN)		
	Treble Switching Step	GTST	-	2	-	dB	V _{IN} =200mVrms, f=10kHz		
MIC	Microphone Voltage Gain	GMIC	4.5	6.0	7.5	dB	V _{IN} =200mVrms GMIC=20log(VOUT/VIN)		

^{*1 *2} Typ. is set to the value descrived in condition.

Min. and Max. mean the error.

⊙BD3861FS

VCC=9V, f=1KHz, VIN=1Vrms, Rg=600 Ω , RL=10k Ω , Ta=25°C, Input Gain=0dB, VOL=0dB, Bass, Middle, Treble=0dB, unless otherwise noted.

Dass	Bass, Middle, Treble=0dB, unless otherwise noted. Limits								
	Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition		
	Circuit Current	IQ	-	13.0	26.0	mA	At no signal		
	Output Voltage Gain	GV	-1.5	0.0	1.5	dB	GV=20log(VOUT/VIN)		
 	Total Harmonic Distortion	THD	-	0.02	0.08	%	400 to 30kHz BPF		
TOTAL	Maximum Output Voltage	VOM	2.0	2.5	-	Vrms	THD=1%		
-	Output Noise Voltage	VNO	-	8.0	15.0	μVrms	Rg=0kΩ, IHF-A		
	Cross-talk between Channels	CT		-80	-70	dB	Rg=0kΩ, IHF-A		
	6dB SW Gain	GV6	5	6	7	dB	VIN=200mVrms GV6=20log(VOUT/VIN)		
	Input Voltage Gain 1	GvmaxI1	-1	*1	+1	dB	VIN=200mVrms From 0 to 10dB Gvmaxl1=20log(VOUT/VIN)		
_	Input Voltage Gain 2	Gvmaxl2	-1.5	*1	+1.5	dB	VIN=200mVrms, From 12 to 26dB GvmaxI2=20log(VOUT/VIN)		
INPUT	Input Gain Switching Step	GvmaxIst	-	2	-	dB	From 0 to 26dB		
=	Input Total Harmonic Distortion	THDI	-	0.02	0.08	%	400 to 30kHz BPF		
	Input Maximum Output Voltage	VOMI	2.0	2.5	-	dB	THD=1%		
	Cross-talk between Selectors	CS	-	-80.0	-70.0	dB	Rg=0kΩ, IHF-A CS=20log(VOUT/VIN)		
	Input Impedance	RI	35.0	50.0	65.0	kΩ	RI=51k×VOUT/ (VIN-VOUT)		
	E Input SW Attenuation	GRE	-	-20.0	-15.0	dB	GRE=20log(VOUT/VIN)		
	Input Volume 1	GIV1	-2	*1	+2	dB	From 0 to -50dB GIV1=20log(VOUT/VIN) From -54 to -70dB		
INPUT	Input Volume 2	GIV2	-3	*1	+3	dB	GIV2=20log(VOUT/VIN)		
P P	Volume Switching Step 1	GIVst1	-	2	-	dB	From 0 to -50dB		
>	Volume Switching Step 2	GIVst2	-	4	-	dB	From -54 to -70dB		
	Maximum attenuation	GminI	-	-	-90.0	dB	IHF-A, GminI=20log(VOUT/VIN)		
OUTPUT	Output Volume	GOV	-1	*1	+1	dB	From 0 to -59dB Gov=20log(VOUT/VIN)		
빌	Output Switching Step	GOVst	-	1	-	dB	From 0 to -59dB		
5≥	Maximum attenuation	GminO	-	-	-90.0	dB	IHF-A GminO=20log(VOUT/VIN)		
တ္တ	Bass Boost Gain	GBB	-2	*1	+2	dB	VIN=200mVrms, f=90Hz, From 0 to 14dB GBB=20log(VOUT/VIN)		
BASS	Bass Cut Gain	GBC	-2	*1	+2	dB	VIN=200mVrms, f =90Hz, From -14 to 0dB GBC=20log(VOUT/VIN)		
	Bass Switching Step	GBST	-	2	-	dB	VIN=200mVrms, f=90Hz		
Щ	Middle Boost Gain	GMB	-2	*1	+2	dB	VIN=200mVrms, From 0 to 12dB GMB=20log(VOUT/VIN)		
MIDDLE	Middle Cut Gain	GMC	-2	*1	+2	dB	VIN=200mVrms, From -12 to 0dB GMC=20log(VOUT/VIN)		
	Middle Switching Step	GMST	-	2	-	dB	VIN=200mVrms		
LE E	Treble Boost Gain	GTB	-2	*1	+2	dB	VIN=200mVrms, f=10kHz From 0 to 12dB GTB=20log(VOUT/VIN)		
TREBLE	Treble Cut Gain	GTC	-2	*1	+2	dB	VIN=200mVrms, f=10kHz From -12 to 0dB GTC=20log(VOUT/VIN)		
	Treble Switching Step	GTST	-	2	-	dB	VIN=200mVrms, f=10kHz		
MIC	Microphone Voltage Gain	GMIC	4.5	6.0	7.5	dB	VIN=200mVrms GMIC=20log(VOUT/VIN)		

^{*1} Typ. is set to the value descrived in condition. Min. and Max. mean the error.

⊙BD3883FS

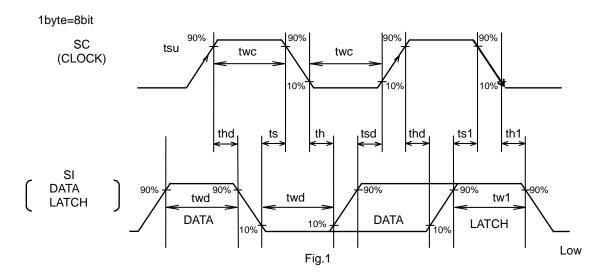
Ta=25°C, VCC=8V, f=1kHz, Vi=200mVrms, RL=10k Ω , Rg=600 Ω , Input Selector=Ach, Input Gain=0dB, Volume=0dB, Bass=0dB, Middle=0dB, Treble=0dB, Surround=OFF, RECOUT=OFF, unless otherwise noted.

	December:		30 110104	Limits		I Imit	Condition
	Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
	Circuit Current	IQ	-	8	21	mA	At no signal
	Total Output Voltage Gain	Gv	-2	0	2	dB	
	Total Harmonic Distortion	THDO	-	0.01	0.1	%	BW=400 to 30kHz
	Maximum Output Voltage	Vomaxo	1.6	2.1	-	Vrms	THD=1% BW=400 to 30kHz
TOTAL	Total Residual Noise Voltage	Vno	-	2	10	μVrms	Rg=0Ω, Vol=-∞dB BW=IHF-A, REAR ATT=-10dB
	Total Output Noise Voltage	Vmno	-	4	15	μVrms	Rg=0Ω, Vol=0dB BW=IHF-A
	Cross-talk between Channels	CTC12	-	-80	-70	dB	Rg=0Ω, BW=IHF-A VOUT=1Vrms
	Input Impedance	Rin	70	100	130	kΩ	
	Output Impedance	Rout	-	-	50	Ω	
INPUT	Cross-talk between Selectors	CTS1	1	-80	-70	dB	VOUT=1Vrms $Rg=0\Omega$, BW=IHF-A
	Volume Control Range	VRI	-90	-87	-84	dB	BW=IHF-A ,Vout=1Vrms
ш	Volume Setting Error 1	VEI1	-2	0	2	dB	0 to -53dB,BW=IHF-A VOUT=1Vrms
VOLUME	Volume Setting Error 2	VEI2	-3	0	3	dB	-54 to -87dB,BW=IHF-A VOUT=1Vrms
>	Maximum Attenuation	Vmin	-	-	-90	dB	BW=IHF-A VOUT=1Vrms
	Volume Input Impedance	Rvin	39	56	73	kΩ	
BASS	Bass Gain	Gb	-17	7.5 to +1	7.5	dB	
BA	Bass Gain Setting Error	BE	-2.5	0	-2.5	dB	
DLE	Middle Gain	Gm	-	14 to +1	4	dB	
MIDD	Middle Gain Setting Error	ME	-2	0	-2	dB	
TREBLE	Treble Gain	Gt	-	14 to +1	4	dB	
TRE	Treble Gain Setting Error	TE	-2	0	2	dB	
JND	Surround In-phase Gain	Vsur1	-2	0	2	dB	
SURROUND	Surround Single-phase Gain	Vsur2	4.3	6.3	8.3	dB	AC-grounding
SUI	Opposite-phase Gain	Vsur3	8	10	12	dB	

[•] This IC is not designed to be radiation-resistant.

● Control signal specifications

- 1. Signal Timing Conditions
 - Data is read on the rising edge of the clock.
 - · Latch is read on the falling edge of the clock.
 - · Latch signal must terminate with the LOW state.
 - To avoid malfunctions, clock and data signals must terminate with the LOW state.



Parameter	Symbol	bol				
Falanetei	Symbol	Min.	Тур.	Max.	Unit	
Minimum Clock Width	twc	2.0	-	-	μs	
Minimum Data Width	twd	2.0	-	-	μs	
Minimum Latch Width	tw1	2.0	-	-	μs	
Data Set-up Time (DATA→CLK)	Tsd	1.0	-	-	μs	
Data Hold Time (CLK→DATA)	Thd	1.0	-	-	μs	
Latch Set-up Time (CLK→LATCH)	ts1	1.0	-	-	μs	
Latch Hold Time (DATA→LATCH)	th1	1.0	-	-	μs	
Latch Low Set-up Time	ts	1.0	-	-	μs	
Latch Low Hold Time	th	1.0	-	-	μs	

2. Voltage Conditions for Control Signals (BD3403FV, BD3861FS)

Parameter	Condition		Unit		
	Condition	Min.	Тур.	Max.	Offic
"H" Input Voltage	Vcc=6.5 to 9.5V	2.6	-	5.5	V
"L" Input Voltage	Vcc=6.5 to 9.5V	0	-	1.1	V

3. Voltage Conditions for Control Signals (BD3883FS)

Parameter	Condition		Lloit		
	Condition	Min.	Тур.	Max.	Unit
"H" Input Voltage	Vcc=6.5 to 9.5V	2.2	-	5.5	V
"L" Input Voltage	Vcc=6.5 to 9.5V	0	-	1.0	V

●Control data format list (BD3403FV)

ddress 1								
D10	D11	D12	D13	D14	D15	D16	D17	
OUTPUT	Volume 1		OUTPUT	Volume 2		Function Select 0 0		
ddress 2		1				1		
D20	D21	D22	D23	D24	D25	D26	D27	
	INPUT '	Volume		Surround 0:OFF 1:ON	0	Function Select	ot O	
ddress 3								
D30	D31 Input Selector	D32	D33 6dB SW 0: 0dB 1:+6dB	D34 IN E MUTE 0:OFF 1:ON	D35 0	D36 Function Select	D37 et 1	
ddress 4			11.002					
D40	D41	D42	D43	D44	D45	D46	D47	
Input Gain/Bass				0: Input Gain 1: Bass	1	Function Selec	et 1	
ddress 5								
D50	D51	D52	D53	D54	D55	D56	D57	
	Middle/	Treble		0: Middle 1: Treble	0	Function Selec	ct 1	
3861FS) ddress 1 D10								
	D11	D12	D13	D14	D15	D16	D17	
	D11 T Volume	D12		D14 Volume 2	D15		D17 n Select 0	
		D12			D15	Functio	n Select	
OUTPU		D12			D15	Functio	n Select	
OUTPU ddress 2 D20	T Volume D21		OUTPUT	Volume 2	D25	Functio 0	n Select 0	
OUTPU ddress 2 D20 ddress 3	T Volume D21	D22 NPUT Volume	OUTPUT	Volume 2	D25 0	Function Select 1	n Select 0 D27	
OUTPU ddress 2 D20	T Volume D21	D22	OUTPUT	Volume 2	D25 0 D35	Function Selection	n Select 0 D27	
OUTPU ddress 2 D20 ddress 3 D30 ddress 4	T Volume D21 I D31 Input Selector	D22 NPUT Volume D32	D23 D33 6dBSW 0: 0dB 1:+6dB	D24 D34 IN E MUTE 0:OFF	D25 0 D35	Function Select 1 D36 Function Select 1 D36 Function Select 0	n Select 0 D27	
OUTPU ddress 2 D20 ddress 3 D30	T Volume D21 I D31	D22 NPUT Volume	D23 D33 6dBSW 0: 0dB	D24 D34 IN E MUTE 0:OFF 1:ON D44	D25 0 D35	Function Selection Selecti	n Select 0 D27	
OUTPU ddress 2 D20 ddress 3 D30 ddress 4 D40	T Volume D21 I D31 Input Selector	D22 NPUT Volume D32	D23 D33 6dBSW 0: 0dB 1:+6dB	D24 D34 IN E MUTE 0:OFF 1:ON	D25 0 D35 0	Function Select 1 D36 Function Select 1 D36 Function Select 0	D27 ct 0 D37 ct 1	
OUTPU ddress 2 D20 ddress 3 D30 ddress 4 D40 ddress 5	D21 D31 Input Selector D41 Input Ga	D22 NPUT Volume D32 D42 in/Bass	D23 D33 6dBSW 0: 0dB 1:+6dB D43	D24 D34 IN E MUTE 0:OFF 1:ON D44 0: Input Gain 1: Bass	D25 0 D35 0 D45	Function Select 1 D36 Function Select 0 D46 Function Select 0	D27 ct 0 D37 ct 1 D47	
OUTPU ddress 2 D20 ddress 3 D30 ddress 4 D40	T Volume D21 I D31 Input Selector D41	D22 NPUT Volume D32	D23 D33 6dBSW 0: 0dB 1:+6dB	D24 D34 IN E MUTE 0:OFF 1:ON D44 0: Input Gain	D25 0 D35 0	Function Select 0 D36 Function Select 0 D46 Function Select 0	D27 ct 0 D37 ct 1 D47	

(BD3883FS)

· Basic Configuration of Control Data Format

← Data input direction

	MSB									LSB
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Data				D	ata				Select	Address

Control Da← Data inpu		-							Select	Address
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Data(1)	Input Gain In			nput Selector Treb			ble fc	0	0	
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Data(2)	Front Volume A				Front Volume B *				0	1
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Data(3)	Bass Gain				Treble Gain				1	0
	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
Data(4)	Data(4) Middle Gain				Time Constan t Select	REC OUT	Surroun d	Rear Volume	1	1

O* indicates 0 or 1.

- By changing the setting of Select Address, four different control formats are selectable. (BD3883FS)
- · At power-on sequence, initialize all data.

Example:

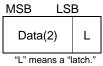
 \leftarrow Data input direction

MSB LSB MSB		ISB LS	LSB MSB		LSB M		ISB	LS	SB
Data(1)	L	Data(2)	L	Data(3)		L	Data(4)		L
"L" means a "latch."									

· After power-on, for the second and subsequent times, only the necessary data can be selected for setting.

Example: When changing the volume:

 \leftarrow Data input direction



• RECOUT, Surround and Rear Volume in Data(4) are Soft-switched using time constants. (BD3883FS)

Block diagram, application circuit, pin assignment

(BD3403FV)

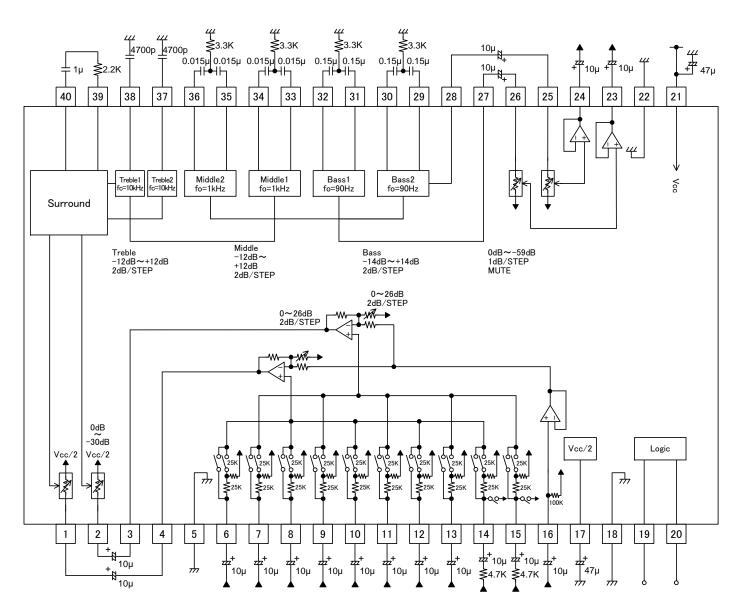
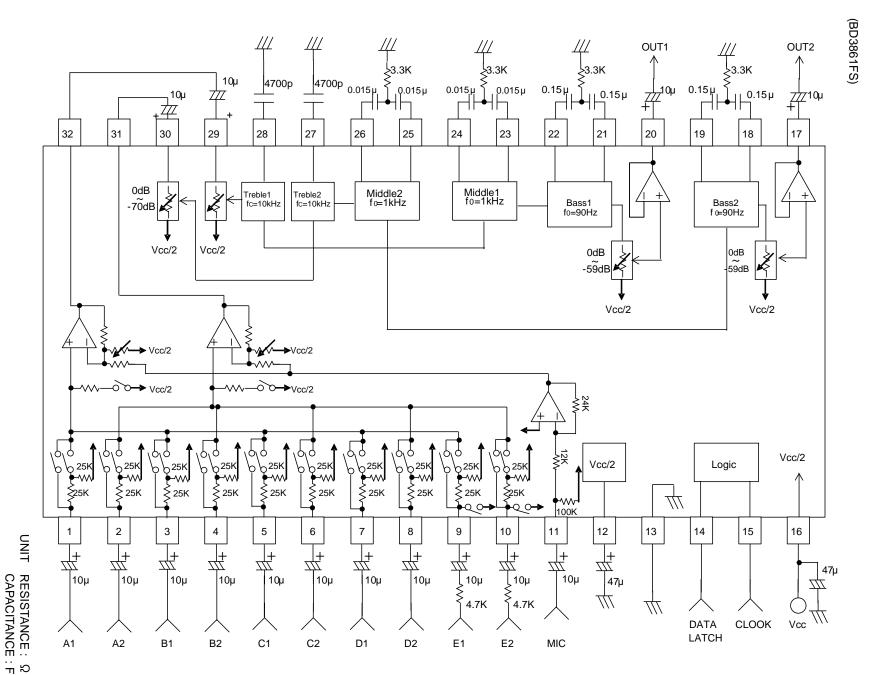


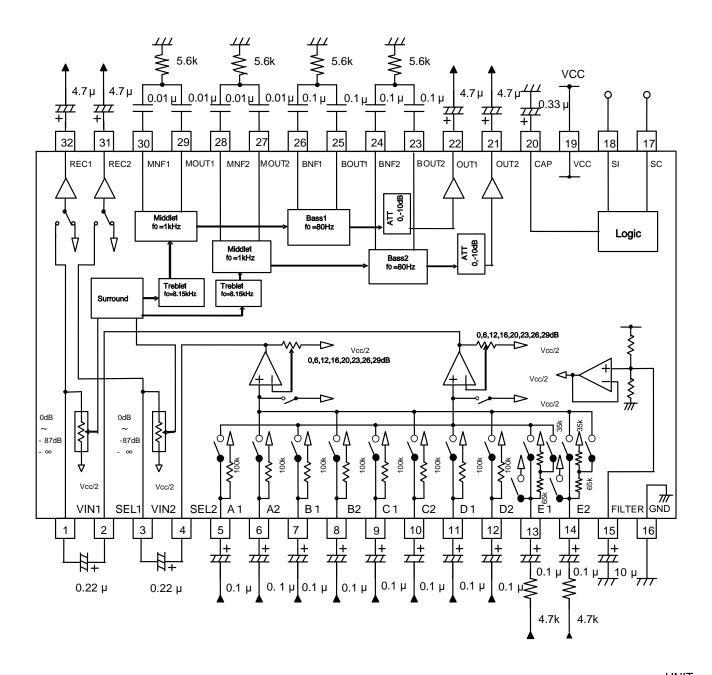
Fig.2

ZIN RESISTANCE : Ω CAPACITANCE : F



www.rohm.com

(BD3883FS)
When using RECOUT:



UNIT RESISTANCE: Ω CAPACITOR: F

Fig.4

(BD3883FS)
When using 2ndHPF:

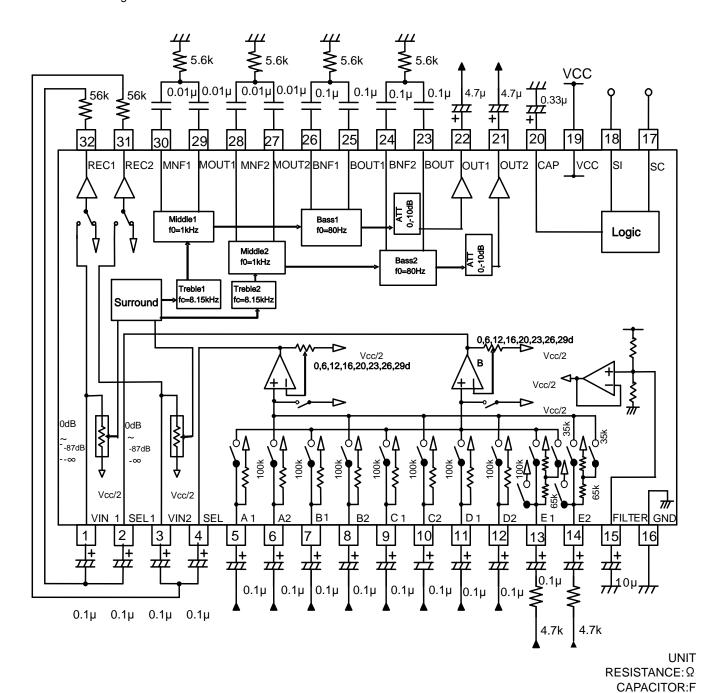


Fig.5

Reference data

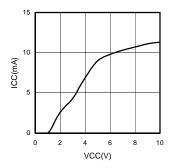


Fig.6 Circuit Current – Supply Voltage (BD3403FV)

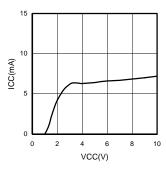


Fig.7Circuit Current – Supply Voltage (BD3883FS)

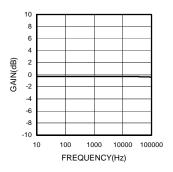


Fig.8 Voltage Gain - Frequency

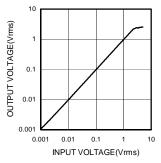


Fig.9 Output Voltage - Input Voltage

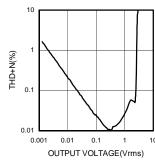


Fig.10 Total Harmonic Distortion ratio - Output Voltage (BD3403FV, BD3861FS)

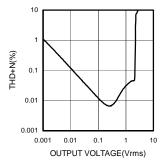


Fig.11Total Harmonic Distortion ratio - Output Voltage (BD3883FS)

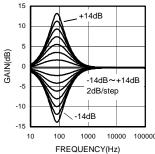


Fig.12 Bass Gain - Frequency (BD3403FV, BD3861FS)

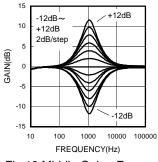


Fig.13 Middle Gain - Frequency (BD3403FV, BD3861FS)

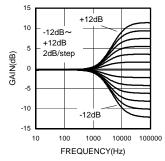


Fig.14 Treble Gain - Frequency (BD3403FV, BD3861FS)

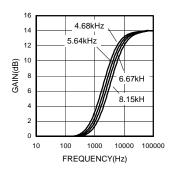


Fig.15 Variable Treble Cut-off Frequency (BD3883FS)

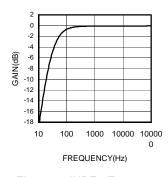


Fig.16 2ndHPF - Frequency (BD3883FS)

Notes for use

- 1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2) Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.

3) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

4) GND potential

Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

5) Thermal design

Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.

6) Short circuit between terminals and erroneous mounting

Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.

7) Operation in strong electromagnetic field

Using the ICs in a strong electromagnetic field can cause operation malfunction.

8) 2-wire serial control

Because SC and SI terminals are designed for inputting high-frequency digital signals, wiring and layout patterns should be routed as not to cause interference with the analog-signal-related lines.

9) E Input external resistance (BD3883FS)

To avoid a sudden noise into E Input, external resistance (4.7kΩ) should be connected as close as possible to the IC terminal.

10) Function switching

Action to absorb shock sounds is taken when switching between the Volume, Treble, Middle and Bass functions.

11) Power-ON Reset (BD3883FS)

A built-in circuit for performing initialization inside the IC at Power-ON is provided. Specifically, the initial states are set as described in the table below. In the case of the setting design, however, to be on the safe side, it is recommended that data shall be sent to all the addresses as initial data at power-ON and, until this sending operation is completed, MUTE shall be applied. To avoid malfunctions, serial data signals must be set to the Low state at power-ON/OFF.

Function	Initial State		
Input Selector	MUTE		
Input Gain	0 dB		
RECOUT	OFF		
Volume	–∞dB		
Surround	OFF		
Treble	0 dB		
Middle	0 dB		
Bass	0 dB		
Rear Volume	0dB		

12) Step switching noise (BD3883FS)

For Surround and Rear Volume, an external capacitor C is attached to the CAP pin to control the switching step noise. In the application circuit, a constant value, as an example, is shown by the CAP pin.

The time constant for charge/discharge of the capacitor C (varying between VBE to 5VBE (2.65V)) controls the slow switching operation.

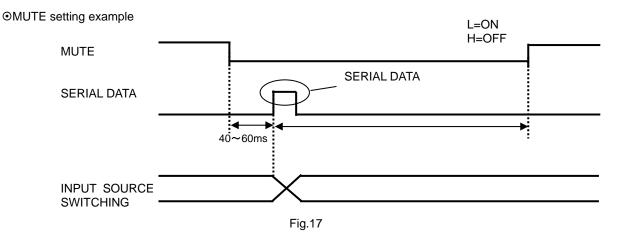
The switching time constant T is calculated as the follows:

 $T=2.55 \times 10^5 \times C$

VBE has temperature characteristics and may affect the value of the time constant T.

13) Input Selector and Input Gain

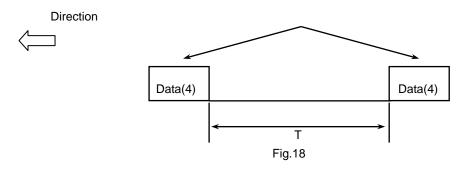
When changing Input Selector or Input Gain, the Soft-switching is not applied. Therefore, it is recommended to implement the MUTE function.



14) Constraints of serial control (BD3883FS)

On Soft-switching of the RECOUT, Surround, and Rear Volume functions, data must not be sent serially to the functions before the switching operation is completed.

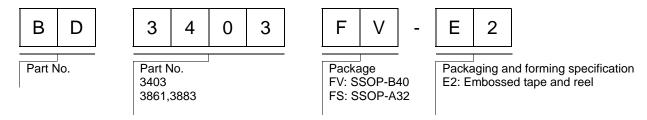
If the function for Soft-switch should serially send the data (Data(4)) on the same Select Address, the time interval between the send operations must be set to 500 -600msec.



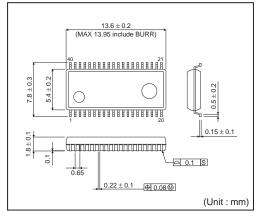
15) Function setting while muting Volume (BD3883FS)

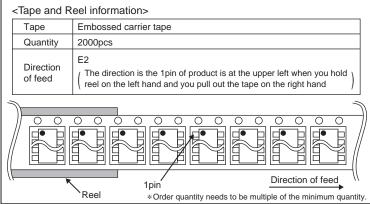
While muting Volume, to avoid increasing residual noise, set Bass, Middle and Treble to 0dB, Surround to OFF, and Rear Volume to -10dB.

Ordering part number

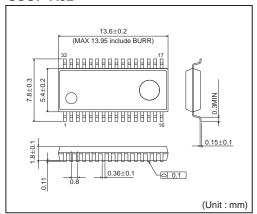


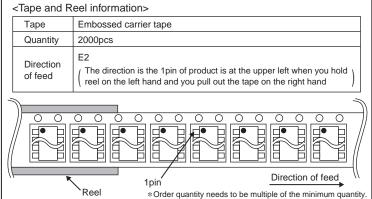
SSOP-B40





SSOP-A32





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JÁPAN		USA	EU	CHINA	
CLAS	SSⅢ	CI VCCIII	CLASS II b	CLASSIII	
CLAS	SSIV	CLASSⅢ	CLASSⅢ		

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 - [f] Sealing or coating our Products with resin or other coating materials
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 - [h] Use of the Products in places subject to dew condensation
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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